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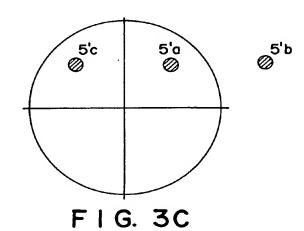
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- (54) Image projection method and semiconductor device manufacturing method using the same.
- (a) An edge emphasis type phase shift reticle is illuminated obliquely, and zeroth order diffraction light and first order diffraction light caused by a fine pattern of the reticle and having substantially the same intensity are incident and distributed on a pupil of a projection optical system, symmetrically with respect to a predetermined axis, whereby the fine pattern is imaged with use of the zeroth order diffraction light and first order diffraction light.



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This invention relates to an image projection method and a semiconductor device manufacturing method using the same. More particularly, the invention is concerned with an improved image projection method suitable for forming on a wafer a circuit pattrn of a linewidth not greater than 0.5 micron and with an improved semiconductor device manufacturing method based on such an image projection method.

The degree of integration of each semiconductor device such as IC, LSI or the like has been increased more and more and, along this, the fine processing technique has been improved considerably. Particularly, the exposure technique which is the major processing technique in semiconductor device manufacturing processes has been advanced into a submicron region, with manufacture of 1 mega-DRAM. A representative exposure apparatus therefor is a reduction projection exposure apparatus, called a stepper. It is not an overestimation to say that the resolution of such a stepper determines the future of semiconductor devices.

Conventionally adopted method for improving the resolution of the stepper is mainly to enlarge the numerical aperture (NA) of a projection optical system (reduction lens system). Since however the depth of focus of a projection optical system is in inverse proportion to the square of the NA, enlarging the NA results in a decrease of the depth of focus, causing a difficulty of forming on a wafer an image of good contrast. In consideration of this problem, recently adoptd method for enhancing the resolution is to use shorter wavelengths for the exposure light, such as by using i-line light (365 nm) or KrF excimer laser light (248 nm) in place of g-line light (436 nm). This relies upon an effect that both the depth of focus and the resolution of an optical system increase in inverse proportion to the wavelength.

On the other hand, independently of enlarging the NA of a projection optical system or using shorter wavelengths of exposure light, there is a method of improving the resolution of a stepper by illuminating a reticle in a specific manner. An example according to this method is that a reticle is illuminated with the light which forms a ring-like effective light source (a virtual light source formed by zeroth order light) at a pupil of a projection optical system. With this method, diffraction light (zeroth and first orders) produced by a circuit pattern of a reticle can be projected onto the pupil of the projection optical system.

Another method for improving the resolution, having been considered preferably, is to use a phase shift reticle (mask). According to this method, a mask of conventional type is locally partly provided with a thin film that imparts to light incident on it a phase shift f 180 deg. relativ to the light incident on the remaining portion. Many types of such phase shift reticles have

been proposed, as referred to in a paper by Fukuda et al ("Nikkei Microdevices", July 1990). A particular phase shift reticle as proposed by Levenson of IBM corporation and called by Fukuda et al as "spatial frequency modulation type", may have an advantage of an enhancement in depth of focus of 50 - 100 % and an enhancement in resolution of 40 - 50 %. However, the phase shift reticle of spatial frequency modulation type involves the problems of:

- (1) Unestablished technique for forming a phase shift film;
- (2) Unestablished CAD technique optimized to a phase shift film;
- (3) Existence of a pattern to which no phase shift film can be put; and
- (4) Unestablished technique for inspection and correction.

Under these circumstances, the phase shift reticle method can not be easily practiced in the semiconductor device manufacturing processes.

On the other hand, there is another type phase shift reticle which is called in the aforementioned paper as "edge emphasis type". This type of phase shift reticle has some advantages over the spatial frequency modulation type phase shift reticle in the point of easiness in manufacture and wideness in applicability: that it does not need complicated manufacturing processes, and that there is no pattern to which a phase shift film can not be put (as contrasted to the case of the spatial frequency modulation type) and, therefore, the method can be applied to complicated peripheral circuit portions.

SUMMARY OF THE INVENTION

As discussed in the foregoing, conventional image projection methods have respective problems in practice, and an improved image projection method which assures enhancement of resolution is desired.

It is accordingly an object of the present invention to provide an image projection method wherein a fine pattern of an original is illuminated and diffraction light caused by the pattern is projected to a pupil of a projection optical system, for projection of an image of the fine pattern, and wherein an edge emphasis type phase shift reticle is used as the original, and the reticle is illuminated with the light which forms at the pupil an effective light source having a higher intensity at its peripheral portion than at its central portion. This assures in a simple manner sufficient enlargement of the depth of focus and resultant enhancement of resolution.

It is another object of the present invention to provide a semiconductor device manufacturing method wherein a circuit patt rn of an original is illuminated and diffraction light caused by the pattern is projected to a pupil of a project in ptical system, for projection and transfer of an image of the circuit pattern into a

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waf r, and wherein an edg mphasis type phase shift reticle is used as the original and the reticle is illuminated with the light which forms at the pupil an effective light source having a higher intensity at its peripheral portion than at its central portion. This assures in a simple manner sufficient enlargement of the depth of focus and resultant enhancement of resolution.

In one preferred form of the present invention, the ffective light source may comprise a ring-like effective light source of substantially circular or rectangular shape, having a center coinciding with the center of the pupil. In another preferred form of the present invention, the original may be illuminated with the light that forms an effective light source at the pupil which light source has portions, defined respectively in four quadrants of an x-y coordinate system having its origin coincident with the center of the pupil and having its x and y axes extended along longitudinal and transverse patterns of the fine pattern, each light source portion providing higher light intensity than that at the center of the pupil and that on the x and y axes.

In this specification, the term "edge emphasis type phase shift reticle" means an original wherein a phase shift film is so formed that zeroth order diffraction light and first order diffraction light to be caused by a pattern of a certain linewidth have substantially the same intensity (amplitude).

These and other objects, features and advantags of the present invention will become more apparent upon a consideration of the following description of the preferred embodiments of the present invention taken in conjunction with the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 is a schematic view for explaining imaging of a fine grating pattern.

Figures 2A - 2C are schematic views each showing a light quantity distribution of diffraction light at a pupil of a projection lens system where a particular reticle is illuminated perpendicularly, wherein Figure 2A corresponds to a case where a conventional reticle is used, Figure 2B corresponds to a case where a spatial frequency modulation type phase shift reticle is used, and Figure 2C corresponds to a case where an dge emphasis type phase shift reticle is used.

Figures 3A - 3C are schematic views each showing a light quantity distribution of diffraction light at a pupil of a projection lens system where a particular reticle is illuminated obliquely, wherein Figure 3A corresponds to a case where a conventional reticle is used, Figure 3B corresponds to a case where a spatial frequency modulation type phase shift reticle is used (for comparison) and is illuminated perpendicularly, and Figure 3C corresponds to a cas where an edge emphasis typ phase shift reticle is used.

Figure 4 is a schematic view of a semiconductor

device manufacturing projection xposure apparatus to which a method according to present invention is applied.

Figures 5A and 5B are schematic views for explaining the operation of the present invention, wherein Figure 5A shows pairs of zeroth order light and first order light at a pupil, when a longitudinal pattern of an edge emphasis type phase shift reticle is imaged, while Figure 5B shows the structure of such an edge emphasis type phase shift reticle.

Figures 6A and 6B are schematic views for explaining an image projection method according to a first embodiment of the present invention, wherein Figure 6A shows a light quantity distribution of an effective light source at a pupil, while Figure 6B is a graph showing the relationship between the depth of focus and the resolution of an imaging system attainable with this embodiment.

Figures 7A and 7B are schematic views for explaining an image projection method according to a second embodiment of the present invention, wherein Figure 7A shows a light quantity distribution of an effective light source at a pupil, while Figure 7B is a graph showing the relationship between the depth of focus and the resolution of an imaging system attainable with this embodiment.

Figures 8A and 8B are schematic views each showing an effective light source forming in the neighbourhood of a light exit surface of an optical integrator, wherein Figure 8A corresponds to a case where an effective light source such as shown in Figure 6A is formed, while Figure 8B corresponds to a case where an effective light source such as shown in Figure 6B is formed.

Figure 9 is a schematic view of a modified form of the apparatus of Figure 4.

Figure 10 is a schematic view of another modified form of the apparatus of Figure 4.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

An integrated circuit pattern for use in manufacture of semiconductor devices is mainly composed of longitudinally and transversely extending basic linear patterns. This is because the design of an integrated circuit is based on longitudinal and transverse directions, namely, x and y directions and, as a result, the pattern of the integrated circuit is much formed by patterns extending in x and y directions. In consideration of this, in an embodiment to be described below, such a feature of an integrated circuit pattern and the characteristic of a diffraction pattern by an edge emphasis type phase shift reticle are "combined", and the illumination method is so arranged that a diffraction pattern to be produced by an integrated circuit pattern f an edge emphasis type phase shift reticle becomes analogous to a diffraction pattern to b produced by

an integrat d circuit pattern of a frequency modulation type phase shift reticle, by which considerable improvement in frequency characteristic in image projection is assured.

Before referring to some embodiments, description will first be made to the manner of imaging of a fine pattern, in cases where a conventional reticle, a frequency modulation type phase shift reticle and an edge emphasis type phase shift reticle are used, respectively.

Figure 1 shows the manner of imaging of a grating pattern 6 having a pitch 2d, when it is illuminated in a perpendicular direction. Diffraction light of zeroth order and positive and negative first orders is incident on a pupil (aperture stop) 1 of a projection optical system 7, and diffraction light of these orders from the projection optical system 7 forms a pattern image on an image plane. Where the pitch of the grating pattern 6 is small, the light quantity distribution of the diffraction light at the pupil 1 determines the resolution of the projection optical system 1.

Figures 2A - 2C each shows a light quantity distribution of diffraction light of different orders, distributed on the pupil 1 (Figure 1), the distribution being represented with the position and size of each hatched circle. Figure 2A corresponds to a case where the grating pattern is formed on a conventional reticle, Figure 2B corresponds to a case where it is formed on a frequency modulation type phase shift reticle, and Figure 2C corresponds to a case where it is formed on an edge emphasis type phase shift reticle. In Figures 2A - 2C, reference characters 3a, 4a and 5a each denotes distribution of zeroth order light; whereas distribution of positive first order light is denoted at 3b, 4b or 4b while distribution of negative first order light is denoted at 3c, 4c or 5c. It is seen from these drawings that in the case of frequency modulation type phase shift reticle, as compared with the conventional reticle, the zeroth order light 4a is extinct and only the positive and negative first order lights 4b and 4c are present. In the case of edge emphasis type phase shift reticle, while the positions of diffraction lights of these orders are the same as those in the case of conventional reticle, the intensity ratio among the zeroth order and positive and negative first order diffraction lights is substantially even, as contrasted to the case of conventional reticle. Character "a" in the drawings denotes the spacing between adjacent diffraction lights. In the case of frequency modulation type phase shift reticle, to be exact, the extinction of the zeroth order light occurs provided that the phase shift film is formed very accurately so that the portion of the grating pattern with phase shift film and the portion of the grating pattern without phase shift film hav the same transmission area. For convenience in xplanation, however, an idealistic case is illustrated

In the frequency modulation type phase shift re-

ticle, distribution f diffraction light on the spatial frequency plan (i. ., pupil plane) has characteristic features that (1) the fr quency is reduced to a half and that (2) no zeroth order light is present. However, other than those, the applicants have paid particular attention to the points that: the spacing "a" on the pupil plane between the two diffraction lights 4c and 4d of the frequency modulation type phase, shift reticle is substantially equal to the spacing "a" between the zeroth order light 5a and the positive (negative) first order diffraction light 5b (5c) of the edge emphasis type phase shift reticle; the two diffraction lights 4c and 4d of the frequency modulation type phase shift reticle have an amplitude ratio (light quantity ratio) of 1:1, while on the other hand the zeroth order diffraction light 5a and the positive (negative) first order diffraction light 5b (5c) of the edge emphasis type phase shift reticle similarly have an amplitude ratio of 1:1. It is to be noted here that the amplitude ratio of an edge emphasis type phase shift reticle is determined by the linewidth of a pattern concerned and the width of a phase shift film concerned; and that the width of the phase shift film is optimized in relation to the linewidth so as to attain an amplitude ratio of 1:1 between the zeroth order light and the positive (negative) first order light. And, the applicants have found that: if the illumination is controlled so that, for a spatial frequency of a linewidth RP concerned, for example, a linewidth of a k_1 factor of about 0.5 (RP = k_1 - λ /NA where λ is the wavelength used and NA is the numerical aperture of the projection optical system), the diffraction light from an edge emphasis type phase shift reticle, passing through the pupil 1 of the projection optical system 7, is composed of zeroth order light and only one of positive first order light and negative first order light, then the diffraction lights distributed on the pupil 1 are at the same positions as those in the case of spatial frequency modulation type phase shift reticle. Thus, in an embodiment to be described below, illumination light is obliquely projected to reticle and, as a result of which, while using an edge emphasis type phase shift reticle, diffraction light distribution (spatial frequency distribution) similar to that as attainable with a spatial frequency modulation type phase shift reticle is formed on the pupil.

When illumination light is obliquely projected to an edge emphasis type phase shift reticle 41 (Figure 5B) and it is imaged through the projection optical system 7 (Figure 1), there is formed on the pupil 1 a spatial frequency distribution such as shown in Figure 3C. The pattern formed on this reticle 41 comprises repeated longitudinal patterns (lines and spaces) of regular intervals each extending in the longitudinal direction as viewed in Figure 3. As a result of oblique incidence of illumination light, the zeroth ord r light 5'a is incident at a certain position within the pupil, deviated from the center of the pupil, the first order diffraction light 5'b is incident at a positi nutsid the pupil 1.

and the negativ first order diffraction light 5'c is incid nt at a certain position within the pupil. If the radius f the pupil is standardized to 1 and the linewidth RP of the repeated linear pattern is RP = $k_1 \cdot \lambda / NA$, then the spacing "a" between the zeroth order light and the positive (negative) first order light, on the pupil, is given by an equation $a = 1/2k_1$. Thus, if $k_1 = 0.5$, then a = 1, and the zeroth order light and the positive (negative) first order light are spaced from each other by a distance corresponding to the radius 1 of the pupil. The longitudinal and transverse lines depicted in Figures 3A - 3C correspond to y and x axes of an x-y coordinate system with an origin coinciding with the center of the pupil, and the y and x axes of the x-y coordinate system are set in accordance with the directions along which the longitudinal and transverse patterns of an integrated circuit pattern extend.

Figure 3A shows a spatial frequency distribution n the pupil 1 in a case where illumination light is projected obliquely to a conventional reticle and it is imaged through the projection optical system 7 (Figure 1). Figure 3B shows a spatial frequency distribution on the pupil 1 in a case where illumination light is projected perpendicularly to a frequency modulation type phase shift reticle, the same as that shown in Figure 2B, and it is imaged through the projection optical system 7 (Figure 1). These are illustrated, for comparison.

Symmetrical disposition of diffraction lights on the pupil 1, with reference to the y axis, such as shown in Figure 3C, assures optimization of defocus characteristic of the longitudinal pattern of a linewidth RP corresponding to an arbitrary value of k1. Thus, as seen from Figures 3B and 3C, in a sense that a pair f diffraction lights of the same intensity (amplitude) pass through the pupil 1, the case of Figure 3B wherein a frequency modulation type phase shift reticle is illuminated perpendicularly and the case of Figure 3C wherein an edge emphasis type phase shift reticle is illuminated obliquely with a certain angle, are fully quivalent to each other. For this reason, if illumination light is obliquely projected to the edge emphasis type phase shift reticle of Figure 5B so that the spatial frequency distribution as shown in Figure 3C are produced on the pupil, then, for a longitudinal linear pattern of a linewidth RP corresponding to an arbitrary value of k_1 (e.g. $k_1 = 0.5$), the edge emphasis type phase shift reticle can provide substantially the same performance as of the frequency modulation type phase shift reticle. This is also the case with the imaging on the pupil 1 of the repeated transverse pattern extending along the x axis. In the case of the conventional reticle, since the zeroth order light and the first order light have different intensities, the effect of oblique light projection does not produce a result equivalent to that of the edge emphasis type phase shift reticle. Namely, because the intensity ratio of diffraction lights passing through the pupil 1 is different, the contrast of an imag in the case of conv ntional r ticle would be reduced by about 10 % as compar d with that in the case of the edge emphasis type phase shift reticle.

As shown in Figure 5A, as regards the imaging of the longitudinal pattern described with reference to Figure 3, the zeroth order diffraction light and the first order diffraction light which are paired on the pupil 1 functions equivalently, such as in the pair of 5p and 5p', the pair of 5q and 5q' and the pair of 5s and 5s'. In Figure 5A, each character without dash denotes zeroth order light which each character with dash denotes first order diffraction light. Namely, when an xy coordinate system similar to that of Figure 3 is defined in Figure 5A, pairs of zeroth order light and first order light incident on those positions having the same x-axis coordinate in the x-y coordinate system while the first order light also pass through the pupil, provide the same effect in respect to the imaging of the longitudinal pattern. Similar relationship applies to the imaging of the transverse pattern, and pairs of zeroth order light and first order light incident on those positions having the same y-axis coordinate in the xy coordinate system while the first order light also pass through the pupil, provide the same effect in respect to the imaging of the longitudinal pattern. Thus, as has been described with reference to Figure-3, if the zeroth order light and the first order light are distributed on the pupil 1 of the projection optical system 7 (Figure 1) at those positions which are symmetrical with respect to the y axis of the x-y coordinate system (in the case of longitudinal pattern) or the x axis of the x-y coordinate system (in the case of the transverse pattern), then optimum illumination and imaging for longitudinal and transverse patterns of a certain linewidth RP is assured. Since this effect applies also to longitudinal and transverse patterns of a linewidth near the optimized linewidth RP, it is possible to improve the defocus characteristic in the linewidth range in which the resolution is to be considered, by adjusting the spatial frequency to the linewidth of a spatial frequency near $k_1 = 0.5$, for example.

The applicants thus proposes to apply the oblique illumination method to an edge emphasis type phase shift reticle 41 such as shown in Figure 5B, by which zeroth order light and first order light having substantially the same intensity are produced on the pupil 1 and, additionally, the zeroth order light and the first order light are distributed symmetrically with respect to the v axis of the x-y coordinate system (for a longitudinal pattern) or to the x axis of the x-y coordinate system (for a transverse pattern), by which further improvement in the defocus characteristic in the imaging of longitudinal and transverse patterns of a linewidth RP is assur d. Here, the obliqu illumination means th illumination based on the light which forms an effective light source (zeroth order light) whose intensity at a peripheral portion of the pupil 1 (off the optical

axis) is sufficintly larger than that at the central prtion of the pupil. More particularly, in this illumination, the edge emphasis type phase shift reticle 41 is illuminated with the light as supplied by a primary light source or a secondary light source having the gravity center of intensity distribution set off the axis of the imaging system.

When an imaging system is optimized to a linewidth RP determined by a certain k_1 , the edge emphasis type phase shift reticle 41 may be such that as shown in Figure 5B the width α of a portion of a phase shift film 41c extending beyond a light blocking portion 41b formed of chromium on a glass substrate 41a is set to be about 0.1 $k_1\lambda$ /NA, when converted with respect to the image plane (wafer surface). This effect applies also to a pattern of a linewidth near this optimized linewidth RP, if a phase shift film with the width α set to about 0.1 $k_1\lambda$ /NA is formed, and thus further improvement in the defocus characteristic is assured.

Referring to Figures 1 and 5B and based on Figure 6, a first embodiment of the present invention will be explained. In this embodiment, the edge emphasis type phase shift reticle 41 of Figure 5B is illuminated with light which forms an effective light source such as shown in Figure 6A, and an image of fine longitudinal and transverse patterns formed on the reticle 41 is projected through the projection optical system 7 of Figure 1. The projection optical system 7 comprises a reduction lens system having a design wavelength of i-line light (365 nm) and an NA of 0.5, and the reticle 41 is illuminated with the light as supplied by a secondary light source having a gravity center of intensity distribution set off the axis of the projection optical system 7. In this embodiment, the amount α of overhanging of the phase shift film 41c of Figure 5B beyond the edge of the light blocking portion 41b is 0.044 micron when converted with respect to the image plane (wafer surface). Since the secondary light source is formed at a position optically conjugate with the pupil 1 of the projection optical system 7, the shape of the secondary light source is analogous to that of the effective light source.

Figure 6A shows the effective light source as formed on the pupil 1 of the projection optical system 7 of Figure 1, by the light which illuminates the reticle 41 of Figure 5B. In Figure 6A, an x-y coordinate system such as described hereinbefore is set with the origin disposed coincident with the center of the pupil. The y axis of the x-y coordinate system corresponds to (or is parallel to) the elongating direction of a longitudinal pattern of the reticle 41, while the x axis of the x-y coordinate system corresponds to (or is parallel to) the elongating direction of a transverse pattern of the reticle 41. The effective light source 41 of Figure 6A comprises, when observed macroscopically, f ur regions (light source portions) disposed in positive and negativ 45-deg. dir ctions from the center of the pupil, each region being locat d in corresponding n

of four quadrants of the x-y coordinate system. If the radius of the pupil is denoted by 1, then each of the regions in the first the fourth quadrants defines a circle of a radius of 0.2, and the centers of these circles are at the coordinates (0.35, 0.35), (-0.35, 0.35), (-0.35, -0.35) and (0.35, -0.35), respectively. The reason why this is in a macroscopic sense is that, in a practical system, each region of the effective light source can be seen as a single region as observed macroscopically, but if it is observed microscopically, there may appear shapes of small lenses of an optical integrator, for example, forming the secondary light source.

The result of computer simulation made to the frequency characteristic of the imaging system of this embodiment, is shown in Figure 6B. Solid line A in the drawing depicts the frequency characteristic in a case where a conventional reticle is imaged with light that forms the effective light source of Figure 6A, and broken line B depicts the frequency characteristic of this embodiment. Solid line C depicts the frequency characteristic in a case where a conventional reticle is illuminated perpendicularly under the condition that σ = 0.5. It is seen from Figure 6B that, where the practical resolution limit is taken as providing a depth of focus of the projection lens system not less than 1.5 micron, the resolution limit of 0.52 micron (broken line C) can be improved to 0.37 micron (solid line A) by application, to a conventional reticle, of the illumination using the light that forms an effective light source such as shown in Figure 6A. Also, it is seen that, with the combination of an edge emphasis type phase shift reticle and the illumination using the light that forms the effective light source of Figure 6A (as in the present embodiment), the resolution limit can be improved to 0.33 micron (solid line B). On the other hand, comparing the depth of focus of the projection lens system while paying attention to a linewidth 0.35 micron, the depth of focus of 0.5 micron (conventional) can be improved to 1.1 micron by the application, to the conventional reticle, of the illumination using the light that forms the effective light source of Figure 6A. Also, with the combination of the edge emphasis type phase shift reticle and the illumination using the light that forms the effective light source of Figure 6A (as in the present embodiment), it can be improved considerably to 1.6 micron. Particularly, the resolution 0.35 micron is the one that enables manufacture of 64 MDRAM, and whether such resolution is attainable or not is very important. The capability of forming a pattern of 0.35 micron through a projection lens system of NA of 0.5 and using i-line, as in the present embodiment, directly leads to a possibility of using a projection lens system of a currently commercially available semiconductor device manufacturing projection exposure apparatus (stepp r) for manufacture DRAMs of 64 megabit or more.

When the effective light source is to be formed with the center (light quantity gravity center) of each

region of the ffective light source being located in the positive or negativ 45 deg. dir ction from th pupil center with respect to the x-y coordinate system of the pupil, it is desired that if the radius of the pupil is taken as 1 the distance of the center of each region from the pupil center is within the range of 0.35 - 0.8. It is not always necessary that these regions are separate and isolated. They may be continuous. In that occasion, it is preferable that one region of the effective light source is connected to an adjacent region at its corner of a rectangular (square) shape having its center coinciding with the pupil center. Also, in that occasion, the overhanging amount α of the phase shift film 41c of the edge emphasis type phase shift reticle 41, beyond the light blocking portion 41b, should be not greater than about 0.2\(\lambda\)NA (converted with respect to the image plane (wafer surface)), from the viewpoint of the linewidth aimed at.

Figure 8 shows a second embodiment of the presnt invention. In this embodiment, the light that forms an effective light source such as shown in Figure 8A is used to illuminate the edge emphasis type phase shift reticle 41 shown in Figure 5B, and an image of fine longitudinal and transverse pattern formed on the reticle 41 is projected through the projection optical system 7 of Figure 1. The projection optical system 7 comprises a reduction lens system of NA of 0.5, having a design wavelength of i-line (365 nm), and the reticle 41 is illuminated with the light supplied from a secondary light source having its intensity distribution gravity center located off the axis of the projection optical system 7. In this embodiment, the overhanging amount a of the phase shift film 41c of Figure 5B, beyond the edge of the light blocking portion 41b, is 0.044 micron, as converted with respect to the image plane (wafer surface).

The effective light source shown in Figure 8B has a rectangular (square) shape with a "hollow" intensity distribution wherein the intensity at the center is low. In Figure 8B, if the radius of the pupil is taken as 1, the length of each side of the inside rectangular periphery is in a range of 0.3 - 0.9 while the length of each side of the outside rectangular periphery is in a range f 0.6 - 1.8. The centers of the inside and outside rectangles coincide with the pupil center (origin of x-y coordinate system). The direction of each side of the inside and outside rectangular peripheries is in parallel to the x axis (direction of a transverse pattern) or the y axis (direction of a longitudinal pattern) of the x-y coordinate system set in alignment with the major directions of the integrated circuit pattern of the reticle 41. Here, the configuration of the effective light source of this embodiment such as above is the one when it is seen macroscopically.

The result of computer simulation mad to the frequency characteristic of the imaging system of this embodiment, is shown in Figure 7B. Solid line A in the drawing depicts the frequency characteristic in a cas

where a conv ntional reticl is imag d with light that forms the eff ctiv light source of Figur 7A, and broken line B depicts the frequency characteristic of this embodiment. Solid line C depicts the frequency characteristic in a case where a conventional reticle is illuminated perpendicularly under the condition that σ = 0.5. It is seen from Figure 7B, particularly from comparison of lines A, B and C, that, where the practical resolution limit is taken as providing a depth of focus of the projection lens system not less than 1.5 micron, in this embodiment the resolution limit can be improved near to 0.33 micron, like the first embodiment, by the combination of an edge emphasis type phase shift reticle and the illumination using the light that forms the effective light source of Figure 7A. On the other hand, comparing the depth of focus of the projection lens system while paying attention to a linewidth 0.35 micron, with the combination of the edge emphasis type phase shift reticle and the illumination using the light that forms the effective light source of Figure 7A, in the present embodiment, it can be improved considerably to 1.6 micron, like the first embodiment. Thus, also in this embodiment, both the depth of focus and the resolution can be improved considerably in the high frequency region. As a result, with the combination of an edge emphasis type phase shift reticle and the illumination using the light that forms an effective light source such as shown in Figure 7A, it becomes possible to form a pattern of 0.35 micron through a projection lens system of NA of 0.5, using i-line.

As regards the shape of the effective light source of this embodiment, when in Figure 7A the length of each side of the outside rectangular periphery is taken as 2a while the length of each side of the inside rectangular periphery is taken as 2b and the radius of the pupil is taken as 1, the quantity (a+b)/2 should preferably be in the range of 0.25 - 0.6. Also, the overhanging amount α of the phase shift film 41c of the reticle 41, beyond the light blocking portion 41b, should be not greater than 0.2 λ /NA (converted with respect to the image plane (wafer surface)), from the viewpoint of the linewidth aimed at.

As regards the shape of the effective light source usable in the present invention, there may be many varieties other than those shown in the first and second embodiments. An example may be an effective light source of ring-like shape with its center coinciding with the pupil center.

Figure 4 shows an embodiment of a semiconductor device manufacturing projection exposure apparatus that uses the method of the present invention.

Ultra-high pressure Hg lamp 11 has its arc placed at a first focal point of an elliptical mirror 12. Light emanating from the Hg lamp 11 is reflected by the elliptical mirror 12 and then by a deflecting mirror 13, and it is focused in the neighbourhood f a second focal point of the elliptical mirror 12. Light entrance end

of a fib r bundle 15 is disposed adjacent to the second focal point, and a shutter 14 is placed just in front of the fiber bundle 15. The fiber 15 has a light exit end adjacent to which a light entrance end of an optical rod 16 is placed. The optical rod 16 serves to transmit (diffuse) the light from the fiber bundle 15 so as to transform non-uniform light intensity distribution, at the light exit end of the fiber bundle 15, to uniform light intensity distribution at the light exit end of the rod. Disposed at the side of the light exit end of the optical rod 16 is an intensity adjusting member 17 and, after it, a wavelength selecting filter 18 is placed. While the fiber bundle 15 has a single light entrance surface, its light exit surface is divided into four sections. The optical rod 16 comprises four rods 16a - 16d corresponding to the four sections of the fiber bundle 15, respectively. The rods 16c and 16d are not illustrated in Figure 4. Also, the intensity adjusting member 17 comprises four elements corresponding to the four rods 16a - 16d, but only two of them are illustrated.

In the apparatus of this embodiment, the edge emphasis type phase shift reticle 41 shown in Figure 5B is illuminated with the light that forms, on the pupil of the projection lens system 42, an effective light source such as shown in Figure 6A, and an image of the circuit pattern of the reticle is projected. Namely, the image projection method having been described with reference to the first embodiment is applied. It is important that the regions of the effective light source defined in the four quadrants (see Figure 6A) of the pupil of the projection lens system 42 have a substantially even intensity ratio. This is because, if the four regions of the effective light source have an imbalance of 5% or more in respect to the intensity ratio, there occurs distortion of image in the defocused state. The intensity adjusting member 17 serves to adjust the intensity ratio of the regions of the effective light source, and the four elements of it may comprise ND filters of variable density, interference filters of variable tilt angle, or the like. They serve to adjust the relative intensity ratio of the lights emanating from the four rods to thereby suppress the imbalance of the intensity ratio of the four sections of the effective light source, to not greater than 5%. The light from each element of the intensity adjusting member 17 goes through the wavelength selecting filter 18 and enters an optical integrator 19. The wavelength selecting filter 18 serves to selectively transmit i-line (365 nm) of the light from the Hg lamp 11, such that it provides exposure light of narrow bandwidth.

The optical integrator 19 comprises a combination of small lenses, and it serves to form, with the four lights incident on it light entrance surface, a secondary light source having a shape analogous to the shape of the effective light source f Figure 6A, wherein the secondary light source is formed in the neighbourhood f the light exit surface of the integrator. The position whereat the secondary light source

is formed is optically conjugat with the pupil of the projection lens system 42 and, through the operation of the optical rod 16, each of the four regions of the secondary light source has a substantially uniform intensity distribution. Aperture stop 20a has four openings corresponding to the shape of the secondary light source formed by the optical integrator 19, and it serves to further rectify the shape of the secondary light source as formed by the integrator 19. The stop 20a may be placed in front of the integrator 19 or at a position optically conjugate with the position illustrated.

Relay lens system 35 and an aperture stop 20b which are in the neighbourhood of the optical integrator 19 are provided to change the manner of illumination in accordance with the type of a reticle to be introduced into the apparatus. This is because those of the semiconductor device manufacturing processes which require a high resolution are practically about one-third of the total processes and, in the remaining processes, a sufficiently sharp pattern image can be projected by using the conventional illumination method and conventional reticles. When a conventional reticle is to be introduced into the apparatus, the optical system from the fiber 15 to the adjusting member 17 is demounted and the relay lens system 35 is mounted thereat. Additionally, the aperture stop 20a is replaced by the aperture stop 20b. Such replacement may be made automatically or manually. The relay lens system 35 is arranged to re-focus the arc image of the elliptical mirror 12, formed at the second focal point of the mirror 12, upon the light entrance surface of the optical integrator 19 through the wavelength selecting filter 18, such that, on the light entrance surface of the integrator 19, a single light beam having a Gaussian intensity distribution wherein the intensity is higher at the center (optical axis) than at a peripheral portion (off the axis) is incident. Thus, the aperture of the stop 20b has a circular shape defined about the optical axis. The relay lens system 35 may be structured so as to place the light exit surface (opening) of the elliptical mirror 12 and the light entrance surface of the optical integrator 19 in an optically conjugate relationship.

Denoted at 21 is a mirror for deflecting the path of light passing through the aperture of the stop 20a, and denoted at 22 is a lens system for projecting the light reflected by the mirror 21 to a half mirror. This lens system 22 plays an important role in controlling the uniformness of the illuminance distribution upon the reticle 41. A portion of the light from the lens system 22 is reflected by the half mirror 23, and this portion is directed by a lens 29 to another half mirror 30. By this half mirror 30, the light is further bisected, and split light beams are directed to corresponding two photoelectric detectors 31 and 32, s parately. The photoelectric detector 31 compris s an intensity distribution detector provided by a CCD, for xample, f

monitoring the intensity distribution or shape of the s condary light source. On the basis of an output signal from the detector 31, the adjustment of the regions

f the secondary light source through the elements of the intensity adjusting member 17 is executed. On the other hand, the photoelectric detector 32 is a component of what can be called an integration exposure meter for monitoring the amount of exposure during the exposure operation. On the basis of an output of the detector 32, the opening and closing of the shutter 14 is controlled, for control of the exposure amount. The half mirror 30 may be replaced by an ordinary mirror and the path of light from the lens system 22 may be selectively changed to the detector 31 side or to the detector 32 side, between the adjustment of the secondary light source and the exposure operation.

The portion of the light from the lens system 22 that passes the half mirror 23, illuminates a blade 24 which is a field stop. The blade 24 comprises a masking blade having an aperture whose shape can be adjusted by a mechanical adjusting means, and it serves to block a desired portion of the light from the lens system 22 against impingement of the same on the reticle 41. The aperture of the blade 24 is in an optically conjugate relationship with the surface of the reticle on which the circuit pattern is formed. The aperture edge position of the blade 24 is adjusted by a driving system (not shown) in accordance with the size of the integrated circuit pattern area of the reticle 41 to be exposed. Denoted at 25 is a mirror, denoted at 26 is a lens system, denoted at 27 is another mirror, and denoted at 28 are another lens system. Through these elements (25 - 28), the light from the secondary light source as formed by the optical integrator impinges and illuminates the reticle 41 which is placed on a reticle stage 51. Also, these elements (25 - 28) serve to project an image of the aperture of the blade 24 upon the reticle 41 and, additionally and through cooperation with some lens or lenses of the projection lens system 42, they serve to project an image of the secondary light source (aperture stop 20a) upon the pupil

f the projection lens system 42. This image of the secondary light source projected on the pupil is what having been called an "effective light source", and this has a light quantity distribution such as shown in Figure 6A.

The projection lens system 42 comprises a lens assembly designed mainly with reference to light of iline. It serves to project a reduced image of the circuit pattern of the reticle 41 on a wafer 43 to thereby transfer the circuit pattern to a resist applied to the wafer 43. Semiconductor chips can be manufactured from the wafer 43 having circuit patterns transferred in this manner. The wafer 43 is attracted to a wafer chuck 44, and it is placed in a stage 45 whose position with respect to an x-y coordinate system can be controlled by means of laser interferometers (not shown) and a driving system (not shown). The stage 45 can operat

to m v th waf r chuck 43 in the dir ction of the optical axis of the projection lens system 42 and als to tilt the wafer chuck 43, so as to focus th wafer 43 surface on the image plane of the projection lens system 42. Denoted at 49 is a reflecting mirror for a laser interferometer fixedly mounted on the wafer stage 45.

Denoted at 46 is a photoelectric detection unit mounted on the stage. The unit 46 has pinholes 46a and 46b as well as photoelectric detectors 47 and 48 corresponding to these pinholes, respectively. The photodetector 47 serves to measure the quantity of light passing through the pinhole 46a, for measurement of non-uniformness on the image plane of the projection lens system 42, for example. On the other hand, the photodetector 48 is provided for the same sake as of the photoelectric detector 31, and it comprises an intensity distribution detector such as a CCD, for example, for measuring the light quantity distribution of the effective light source upon the pupil, actually through the intervention of the projection lens system 42. Thus, the adjustment of the regions of the effective light source (secondary light source) with the elements of the intensity adjusting member 17 may be executed by using the output of the photoelectric detector 48 at the stage 45 side. Also, the output of the photoelectric detector 48 may be used to calibrate the adjustment of the intensities of the regions of the secondary light source by the photoelectric detector 31 at the illumination system side. Figure 8A shows the secondary light source as the optical integrator 19 is seen through the aperture stop 20a. Hatched portions in Figure 8A depict the portions blocked by the stop 20a, and rectangular blank portions correspond to the openings of the stop 20a. Each of small squares constituting one blank portion corresponds to one of the small lenses (their sections) constituting the optical integrator 19. The integrator 19 may be formed by a combination of small lenses each having a hexagonal or circular sectional shape. As in the preceding embodiment, also in Figure 8A, the longitudinal direction as viewed in the drawing corresponds to the y axis of the x-y coordinate system, and the transverse direction corresponds to the x axis of the x-y coordinate system. The origin of the x-y coordinate system coincides with the center as viewed in the drawing, namely, the center (optical axis) of the optical integrator 19. The x and y axes of the x-y coordinate system are set in alignment with the axes of the orthogonal coordinates used in the design of the circuit pattern of the reticle 41. These directions correspond to the directions of elongation of longitudinal and transverse linear patterns, respectively, mainly by which the circuit pattern of the reticle 41 is defined. It may be said that these directions correspond to the longitudinal and transverse directions of the outside periphery of the r ticle 41 which has a square shap . Further, in Figur 8A, the outside circl depicts a circle which corresponds to the pupil of the

projection I ns syst m. As shown in Figur 8A, wh n an effective light source having a certain light quantity distribution is to be actually provided, it is restrict-

d by the sectional shape of each small lens of the optical integrator 19 and/or the outside general shape of it. Thus, if the optical integrator 19 is provided by four small lens groups such as shown in Figure 10, then, in order to attain the effective light source such as in the first embodiment, it is necessary to take some measures to assure that light does not pass through the hatched portions in Figure 8A. For this reason, in this embodiment, the arrangement shown in Figure 8A is adopted to attain the effective light source shown in Figure 6A. Generally, in an illumination system for providing a high resolution, the size of the optical integrator 19 may be larger than that required in a conventional illumination system, and it may be more advantageous if the outside peripheral portion of the illumination system having a larger view angle is usable. For example, when the largest view angle of the illumination system is taken as 1, in a conventional illumination system it may be preferable to use an optical integrator of a radius not greater than 0.5; whereas in an illumination system for high resolution it may be preferable to use an optical integrator 19 having its small lenses distributed within a circle of a maximum radius 0.8, although those small lenses disposed in the central portion are not used. Thus, in the present embodiment, the size of the optical integrator as well as the effective diameter of the other portion of the illumination system are set while taking into account both of such a conventional type illumination system and a high-resolution type illumination system (i.e. to be used in both cases).

In the apparatus of this embodiment, in accordance with the type of a reticle to be used, an illumination system corresponding to the reticle concerned can be selected. This makes it possible to provide an exposure optical system best suited to the parameters (such as minimum linewidth, for example) of the circuit pattern. The selection of the illumination system may be made automatically by, for example, reading the linewidth information recorded in the form of bar code on the reticle by using a bar code reader or the like and by inputting the information into the control computer of the apparatus.

There may be a problem in relation to changing the illumination system, i.e., a possibility that the illuminance distribution on the reticle shifts with the changing. If this occurs, the illuminance distribution can be adjusted finely by adjusting the lens system 22. Such fine adjustment of the illuminance distribution can be done by changing the interval or intervals of the lenses constituting the lens system 22, along the optical axis of the lens. Alternatively, the lens system 22 may be replaced by a separate lens system prepared beforehand. In that occasion, plural lens systems like the lens system 22 may be prepared and

they may be used interchangeably in acc rdance with the type of a reticle used.

In the pres nt embodiment, an ffective light source such as shown in Figure 6A is formed on the pupil of the projection lens system 42 and, in accordance with the method described with reference to the first embodiment, an image of a circuit pattern of an edge emphasis type phase shift reticle is projected. However, it is easy to modify the structure so that an effective light source such as shown in Figure 7A is formed on the pupil of the projection lens system 42 and the image of the circuit pattern of the edge emphasis type phase shift reticle is projected in accordance with the method described with reference to the second embodiment. In order to practice the method of the second embodiment, as an example a light (reversal Gaussian distribution) having a higher intensity at its peripheral portion than at its central portion may be projected to the optical integrator 19 while, on the other hand, an aperture stop effective to define the secondary light source of Figure 8B may be placed just after the optical integrator 19.

Figures 9 and 10 are fragmentary schematic views each showing a modified form of the Figure 4 apparatus. In these drawings, like numerals as of those of the Figure 4 are assigned to corresponding elements. Further, since those elements disposed below the reticle 41 are similar to those of Figure 4, they are not illustrated in these drawings.

An important feature of the Figure 9 apparatus resides in that the optical integrator 19 itself is changed in response to changing the illumination condition in accordance with the type of a reticle to be used. This can widen the latitude in respect to the placement of small lenses constituting the optical integrator 19. The widened latitude of placement of the small lenses appears in Figure 9 as separately disposed small lens groups of the optical integrator 19. Like the Figure 4 apparatus, the elements of the optical rod 16 correspond to the lens groups of the optical integrator 19. Among the small lenses of each lens group corresponding to one rod, uniform illuminance is attained. This contributes to uniformizing the intensity distribution of a partial secondary light source (effective light source) defined by this lens group. Denoted in Figure 9 at 18' is a wavelength selecting filter of the illumination system prepared for replacement, and denoted at 19' is an optical integrator of the illumination system prepared to for replacement. The optical integrator 19' has essentially the same structure as of that shown

An important feature of the Figure 10 apparatus resides in that two light paths are defined partially in the illumination system and these two light paths are used interchangedly in accordance with the typ of a reticle used and by insertion or xtracti n of mirrors 13 and 21. The upp r light path in Figure 10, being deflected by th mirrors 13 and 21, corresponds t the

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high-resolution illumination system to be used for an dge emphasis type phase shift r ticl 41, while th lower light path being deflected by the mirrors 13' and 21' corresponds to an ordinary illumination system to be used in a process in which only a resolution not lower than 1.0 (k₁), for example, is required. Denoted at 36 in Figure 10 is a relay optical system.

In the apparatuses shown in Figures 4, 8 and 9, only one Hg lamp 11 is used. However, plural light sources may be used. For example, in the apparatus of Figure 9, separate Hg lamps may be used in relation to the pair of light paths. Further, in the apparatuses of Figure 4, 8 and 9, the fiber bundle 15 may have a light exit surface of rectangular shape while, on the other hand, an aperture stop for defining the secondary light source of Figure 8B may be disposed just after the optical integrator 19. Thus, the shape of the fiber bundle 15 may be modified to assure enhancement in the efficiency of light utilization.

Since an edge emphasis type phase shift reticle can be applied to light of a wavelength 190 - 250, it is possible to provide an apparatus which includes a KrF r ArF excimer laser as a light source. When an excimer laser is used, the illumination system may be provided with a scanning system, for example, for scanning with respect to time the optical integrator with an xpanded laser light. If laser light is inputted obliquely to an edge emphasis type phase shift reticle so as to form, with the scanning illumination using the laser light, an effective light source of Figure 6A or 7A on the pupil of the projection optical system, then the image projection method described with reference to the first or second embodiment is accomplished.

Further, in the apparatuses shown in Figures 4, 8 and 9, an image of a pattern of an edge emphasis type phase shift reticle is projected through the projection lens system 42. However, it is possible to use a projection mirror system in place of the lens system, to project an image of the pattern of the edge emphasis type phase shift reticle.

As described hereinbefore, in the present invention, an edge emphasis type phase shift reticle is illuminated with light that forms on a pupil of a projection optical system an effective light source having a higher intensity at a peripheral portion thereof than at its central portion, by which both the resolution limit of the projection optical system and the depth of focus in the neighbourhood of the resolution limit can be improved considerably. Namely, the present invention assures manufacture of 64 MDRAMs, while using an edge emphasis type phase shift reticle (which is easy to prepare) and making small modification to an exposure apparatus having a projection optical system with NA = 0.5 and a design wavelength of i-line (which is currently commercially available).

While the invention has been described with reference to the structures disclosed herein, it is not confin d to the details set forth and this application is intended to cover such modifications or changes as may come within the purposes of the improvements or the scope of the following claims.

Claims

- 1. In an image projection method wherein a fine pattern of an original is illuminated and wherein diffraction light caused by the fine pattern is projected to a pupil of a projection optical system, for projection of an image of the fine pattern, the improvements residing in preparing an edge emphasis type phase shift reticle as the original, and illuminating the reticle with light which is effective to define on the pupil an effective light source having a higher intensity at its peripheral portion than at its central portion.
- A method according to Claim 1, wherein the effective light source comprises a ring-like effective light source having its center coinciding with the center of the pupil.
- A method according to Claim 2, wherein the effective light source comprises a ring-like effective light source of substantially rectangular shape.
 - A method according to Claim 2, wherein the effective light source comprises a ring-like effective light source of substantially circular shape.
 - 5. A method according to Claim 1, wherein, when an x-y coordinate system having its origin coinciding with the center of the pupil and having its x and y axes extending along directions of elongation of longitudinal and transverse patterns of the fine pattern, the original is illuminated with such light that defines an effective light source having light source portions disposed in four quadrants of the x-y coordinate system and having a higher intensity than at the center of the pupil and on the x and y axes.
- 6. A method according to Claim 5, wherein adjacent ones of the light source portions defined in the four quadrants are positioned symmetrically with respect to one of the x and y axes of the x-y coordinate system.
 - A method according to Claim 6 wherein the light source portions in the four quadrants have substantially the same intensity.
- 8. In a semiconductor device manufacturing method wherein a circuit patt rn of an original is illuminated and wherein diffraction light caused by the circuit pattern is projected in a pupil of a projic-

tion optical system and an image of the circuit pattern is project d on a wafer, whereby the imag of the circuit pattern is transferred to the wafer, the improvements residing in preparing an edge emphasis type phase shift reticle as the original, and illuminating the reticle with light which is effective to define on the pupil an effective light source having a higher intensity at its peripheral portion than at its central portion.

 A method according to Claim 8, wherein the effective light source comprises a ring-like effective light source having its center coinciding with the center of the pupil.

 A method according to Claim 9, wherein the effective light source comprises a ring-like effective light source of substantially rectangular shape.

 A method according to Claim 9, wherein the effective light source comprises a ring-like effective light source of substantially circular shape.

12. A method according to Claim 8, wherein, when an x-y coordinate system having its origin coinciding with the center of the pupil and having its x and y axes extending along directions of elongation of longitudinal and transverse patterns of the fine pattern, the original is illuminated with such light that defines an effective light source having light source portions disposed in four quadrants of the x-y coordinate system and having a higher intensity than at the center of the pupil and on the x and y axes.

13. A method according to Claim 12, wherein adjacent ones of the light source portions defined in the four quadrants are positioned symmetrically with respect to one of the x and y axes of the x-y coordinate system.

14. A method according to Claim 12, wherein the light source portions in the four quadrants have substantially the same intensity.

15. In a semiconductor device manufacturing method wherein a circuit pattern of an original is illuminated and wherein diffraction light caused by the circuit pattern is projected on a pupil of a projection optical system and an image of the circuit pattern is projected on a wafer, whereby the image of the circuit pattern is transferred to the wafer, the improvements residing in preparing an edge emphasis type phase shift reticle as the original, and illuminating the reticl obliquely so that z roth order diffraction light and first order diffraction light caused by the pattern of the reticle are distributed on the pupil, symmetrically with respect

to a predetermined axis, such that by using the zeroth order diffraction light and the first order diffraction light the image of the pattern f th reticle is projected.

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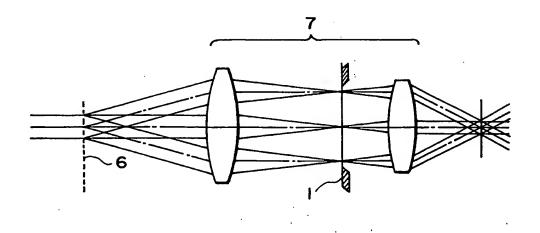
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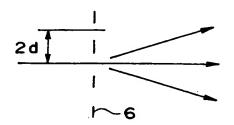
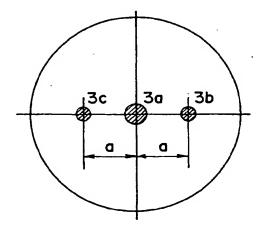
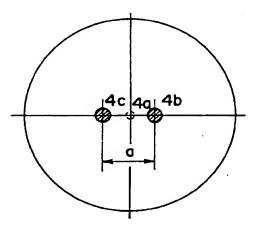


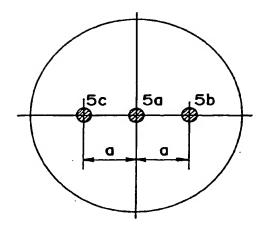
FIG. I



F I G. 2A



F I G. 2B



F I G. 2C

3'b Ø

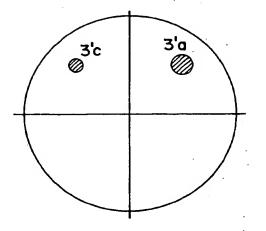


FIG. 3A

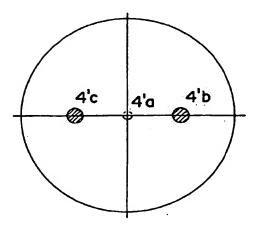


FIG. 3B

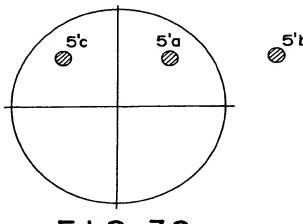
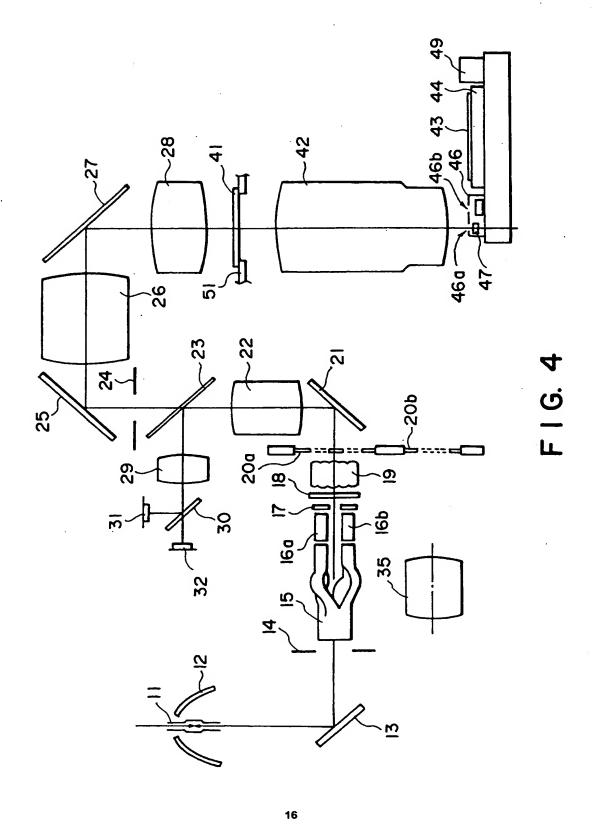


FIG. 3C



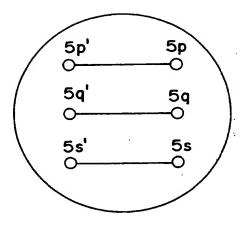
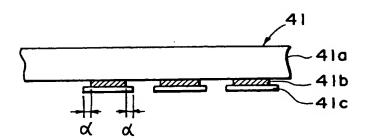
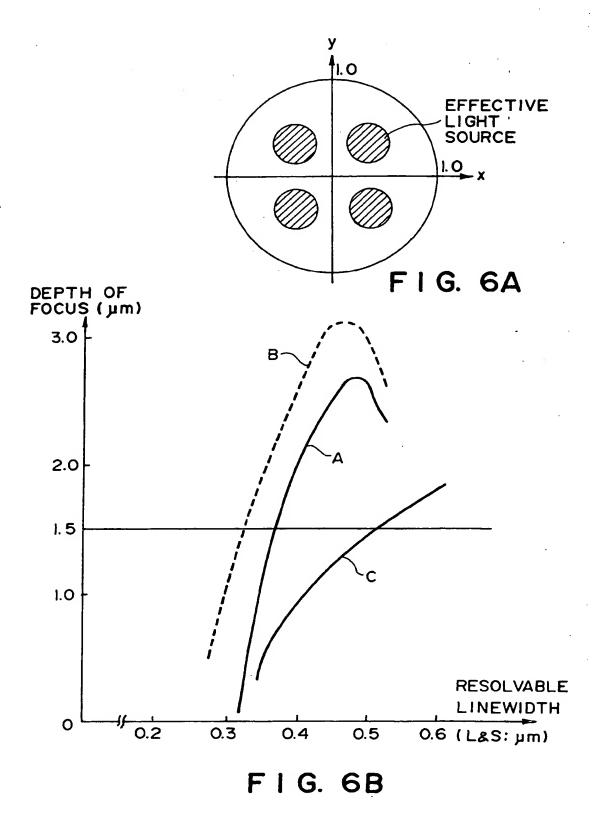
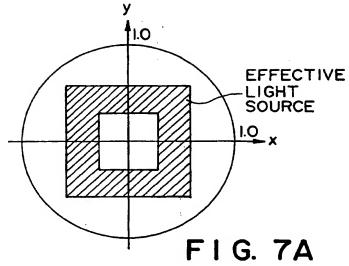


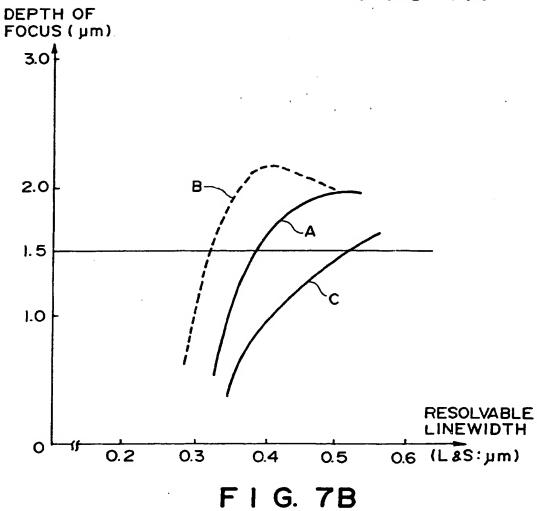
FIG. 5A



F I G. 5B







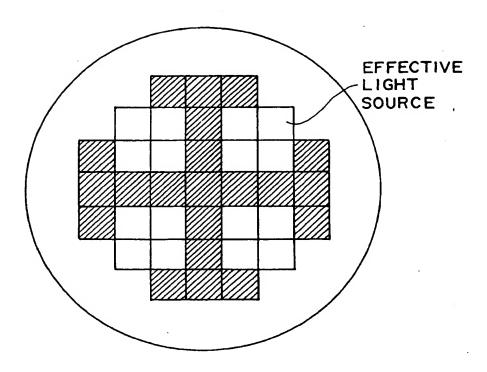


FIG. 8A

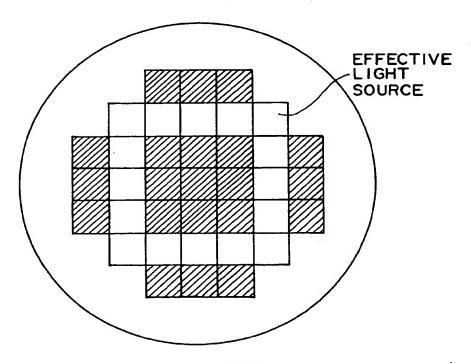
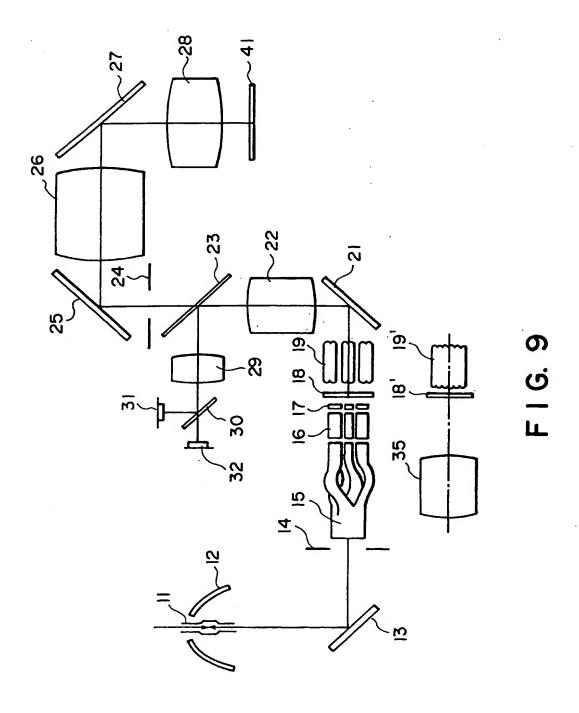
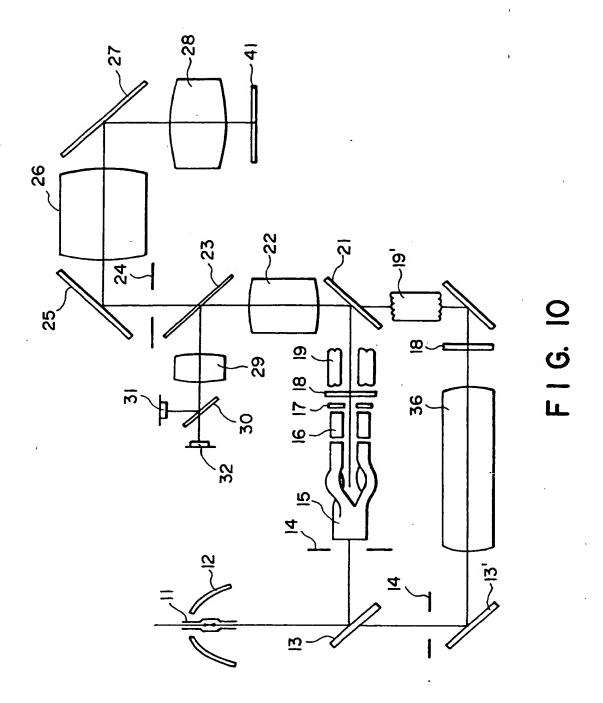


FIG. 8B







EUROPEAN SEARCH REPORT

Application Numb

EP 92 30 7014

DOCUMENTS CONSIDERED TO BE RELEVANT				
Category		indication, where appropriate.	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int. Cl.5)
X	US-A-3 795 446 (JOH * column 1, line 30 * column 3, line 30	HN KENNETH HOUSTON) 8 - column 2, line 17 * 9 - line 65 * 3 - column 8, line 33;	1	G02B5/32 G03F7/20
Y	Tigures / 3	•	5-7, 12-15	
Y	US-A-4 159 164 (H.		5-7, 12-15	
A	* the whole documen	nt *	1-4,8-11	
A	US-A-4 547 037 (STE * column 3, line 1 * column 5 *	EVEN K.CASE) - line 18 *	1-15	
		11 - line 28; claims		
A	FR-A-1 579 159 (PHI * page 1, line 1 - * page 1, line 41 -	line 3 *	1,8,15	TECHNICAL FIELDS SEARCHED (Int. Cl.5)
				G02B G03F
The present search report has been drawn up for all claims				
Place of search Date of completion of the search BERLIN 18 SEPTEMBER 1992			Examiner MANNTZ W.	
CATEGORY OF CITED DOCUMENTS T: theory or principle underlying the im E: earlier patient document, but publish after the filing date Y: particularly relevant if combined with another document of the same category L: document cited in the application A: technological background				invention shed on, or
O: non-written disclosure A: member P: Intermediate document document			he same patent family, corresponding	

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